LM94022/-Q1 1.5-V, SC70, Multi-Gain Analog Temperature Sensor With Class-AB Output

1 Features

- LM94022/-Q1 is AEC-Q100 Grade 0 qualified and is Manufactured on an Automotive Grade Flow
- Low 1.5-V to 5.5-V Operation With Low 5.4-µA Supply Current
- Push-Pull Output With ±50-µA Source Current Capability
- Four Selectable Gains
- Very Accurate Over Wide Temperature Range of −50°C to +150°C:
  - ±1.5ºC Temperature Accuracy for 20ºC to 40ºC Range
  - ±1.8ºC Temperature Accuracy for –50ºC to 70ºC Range
  - ±2.1ºC Temperature Accuracy for –50ºC to 90ºC Range
  - ±2.7ºC Temperature Accuracy for –50ºC to 150ºC Range
- Output is Short-Circuit Protected
- Extremely Small SC70 Package
- For the Similar Functionality in a TO-92 Package, See LMT84, LMT85, LMT86, or LMT87
- Footprint Compatible With the Industry-Standard LM20 Temperature Sensor

2 Applications

- Automotive
- Cell Phones
- Wireless Transceivers
- Battery Management
- Disk Drives
- Games
- Appliances

3 Description

The LM94022/-Q1 device is a precision analog output CMOS integrated-circuit temperature sensor with selectable linear negative temperature coefficient (NTC). A class-AB output structure gives the LM94022/-Q1 strong output source and sink current capability for driving heavy transient loads such as that presented by the input of a sample-and-hold analog-to-digital converter. The low 5.4-µA supply current and 1.5-V operating voltage of the LM94022/-Q1 make it ideal for battery-powered systems as well as general temperature-sensing applications.

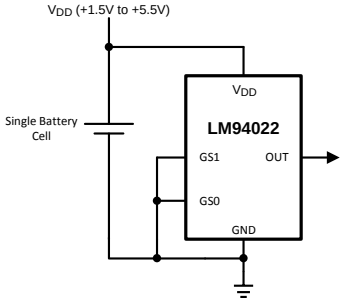
The Gain Select 1 (GS1) and Gain Select 0 (GS0) logic inputs select one of four gains for the temperature-to-voltage output transfer function: −5.5 mV/°C, −8.2 mV/°C, −10.9 mV/°C, and −13.6 mV/°C. Selecting –5.5 mV/°C (GS1 and GS0 both tied low), allows the LM94022/-Q1 to operate down to 1.5-V supply while measuring temperature over the full range of −50°C to +150°C. Maximum temperature sensitivity, –13.6 mV/°C, is selected when GS1 and GS0 are both tied high. The gain-select inputs can be tied directly to V_{DD} or Ground without any pullup or pulldown resistors, reducing component count and board area. These inputs can also be driven by logic signals allowing the system to optimize the gain during operation or system diagnostics.

Device Information(1)

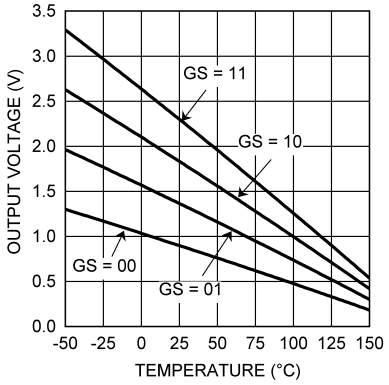
PART NUMBER	PACKAGE	BODY SIZE (NOM)
LM94022	SC70 (5)	2.00 mm × 1.25 mm
LM94022-Q1		

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Full-Range Celsius Temperature Sensor (–50°C to +150°C) Operating from a Single Cell Battery



Output Temperature Characteristic



An IMPORTANT NOTICE at the end of this data sheet addresses availability, warranty, changes, use in safety-critical applications, intellectual property matters and other important disclaimers. PRODUCTION DATA.

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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision E (June 2013) to Revision F — **Page**

- Added or changed: *Pin Configuration and Functions* section, *ESD Ratings* table, *Feature Description* section, *Device Functional Modes*, *Application and Implementation* section, *Power Supply Recommendations* section, *Layout* section, *Device and Documentation Support* section, and *Mechanical, Packaging, and Orderable Information* section ... 1

Changes from Revision D (February 2013) to Revision E — **Page**

- added parabolic equation for LM94022/-Q1 ... 1

Changes from Revision C (May 2005) to Revision D — **Page**

- Changed layout of National Data Sheet to TI format ... 17

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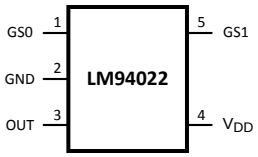
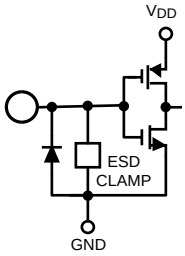
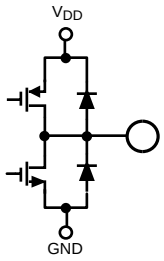
5 Pin Configuration and Functions

DCK Package
5-Pin SC70
Top View



Pin Functions

PIN		TYPE	EQUIVALENT CIRCUIT	FUNCTION
NAME	NO.			
GS1	5	Logic Input		Gain Select 1 - One of two logic inputs for selecting the slope of the output response
GS0	1	Logic Input		Gain Select 0 - One of two logic inputs for selecting the slope of the output response
OUT	3	Analog Output		Outputs a voltage which is inversely proportional to temperature
V_{DD}	4	Power	—	Positive Supply Voltage
GND	2	Ground	—	Power Supply Ground

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6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)(2)

	MIN	MAX	UNIT
Supply Voltage	−0.3	6	V
Voltage at Output Pin	−0.3	(V_{DD} + 0.5)	V
Output Current		±7	mA
Voltage at GS0 and GS1 Input Pins	−0.3	6	V
Input Current at any pin(3)		5	mA
Maximum Junction Temperature, T_{JMAX}		150	°C
Storage temperature, T_{stg}	−65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) Soldering process must comply with Reflow Temperature Profile specifications. Refer to http://www.ti.com/packaging
(3) When the input voltage (V_I) at any pin exceeds power supplies (V_I < GND or V_I > V^+), the current at that pin should be limited to 5 mA.

6.2 ESD Ratings

		VALUE	UNIT
$V_{(ESD)}$ Electrostatic discharge	Human body model (HBM)(1)(2)	±2500	V
	Machine model(2)	±250	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) The human body model is a 100-pF capacitor discharged through a 1.5-kΩ resistor into each pin. The machine model is a 200-pF capacitor discharged directly into each pin.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)(1)

	MIN	MAX	UNIT
Free Air or Specified Temperature (T_{MIN} ≤ T_A ≤ T_{MAX})	−50	150	°C
Supply Voltage (V_{DD})	1.5	5.5	V

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating Ratings indicate conditions for which the device is functional, but do not guarantee specific performance limits. For guaranteed specifications and test conditions, see the Electrical Characteristics. The guaranteed specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.

6.4 Thermal Information

THERMAL METRIC(1)		LM94022, LM94022-Q1 DCK (SC70) 5 PINS	UNIT
$R_{\theta JA}$	Junction-to-ambient thermal resistance	415	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC Package Thermal Metrics* application report, SPRA953.

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6.5 Electrical Characteristics

Unless otherwise noted, these specifications apply for V_{DD} = 1.5 V to 5.5 V; all limits $T_A = T_J$ = 25°C unless otherwise specified. These limits do not include DC load regulation. These stated accuracy limits are with reference to the values in the Table 2.

PARAMETER	CONDITIONS		MIN	TYP(1)	MAX(2)	UNIT
ACCURACY CHARACTERISTICS						
Temperature Error(3)	GS1 = 0 GS0 = 0	T_A = +20°C to +40°C; V_{DD} = 1.5 V to 5.5 V	–1.5		1.5	°C
		T_A = +0°C to +70°C; V_{DD} = 1.5 V to 5.5 V	–1.8		1.8	°C
		T_A = +0°C to +90°C; V_{DD} = 1.5 V to 5.5 V	–2.1		2.1	°C
		T_A = +0°C to +120°C; V_{DD} = 1.5 V to 5.5 V	–2.4		2.4	°C
		T_A = +0°C to +150°C; V_{DD} = 1.5 V to 5.5 V	–2.7		2.7	°C
		T_A = −50°C to +0°C; V_{DD} = 1.6 V to 5.5 V	–1.8		1.8	°C
	GS1 = 0 GS0 = 1	T_A = +20°C to +40°C; V_{DD} = 1.8 V to 5.5 V	–1.5		1.5	°C
		T_A = +0°C to +70°C; V_{DD} = 1.9 V to 5.5 V	–1.8		1.8	°C
		T_A = +0°C to +90°C; V_{DD} = 1.9 V to 5.5 V	–2.1		2.1	°C
		T_A = +0°C to +120°C; V_{DD} = 1.9 V to 5.5 V	–2.4		2.4	°C
		T_A = +0°C to +150°C; V_{DD} = 1.9 V to 5.5 V	–2.7		2.7	°C
		T_A = −50°C to +0°C; V_{DD} = 2.3 V to 5.5 V	–1.8		1.8	°C
	GS1 = 1 GS0 = 0	T_A = +20°C to +40°C; V_{DD} = 2.2 V to 5.5 V	–1.5		1.5	°C
		T_A = +0°C to +70°C; V_{DD} = 2.4 V to 5.5 V	–1.8		1.8	°C
		T_A = +0°C to +90°C; V_{DD} = 2.4 V to 5.5 V	–2.1		2.1	°C
		T_A = +0°C to +120°C; V_{DD} = 2.4 V to 5.5 V	–2.4		2.4	°C
		T_A = +0°C to +150°C; V_{DD} = 2.4 V to 5.5 V	–2.7		2.7	°C
		T_A = −50°C to +0°C; V_{DD} = 3.0 V to 5.5 V	–1.8		1.8	°C
	GS1 = 1 GS0 = 1	T_A = +20°C to +40°C; V_{DD} = 2.7 V to 5.5 V	–1.5		1.5	°C
		T_A = +0°C to +70°C; V_{DD} = 3.0 V to 5.5 V	–1.8		1.8	°C
		T_A = +0°C to +90°C; V_{DD} = 3.0 V to 5.5 V	–2.1		2.1	°C
		T_A = +0°C to +120°C; V_{DD} = 3.0 V to 5.5 V	–2.4		2.4	°C
		T_A = 0°C to +150°C; V_{DD} = 3.0 V to 5.5 V	–2.7		2.7	°C
		T_A = −50°C to +0°C; V_{DD} = 3.6 V to 5.5 V	–1.8		1.8	°C

(1) Typicals are at $T_J = T_A$ = 25°C and represent most likely parametric norm.
(2) Limits are warrantied to TI's AOQL (Average Outgoing Quality Level).
(3) Accuracy is defined as the error between the measured and reference output voltages, tabulated in the Transfer Table at the specified conditions of supply gain setting, voltage, and temperature (expressed in °C). Accuracy limits include line regulation within the specified conditions. Accuracy limits do not include load regulation; they assume no DC load.

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Electrical Characteristics (continued)

Unless otherwise noted, these specifications apply for V_{DD} = 1.5 V to 5.5 V; all limits $T_A = T_J$ = 25°C unless otherwise specified. These limits do not include DC load regulation. These stated accuracy limits are with reference to the values in the Table 2.

PARAMETER		CONDITIONS		MIN	TYP(1)	MAX(2)	UNIT
	Sensor Gain	GS1 = 0, GS0 = 0			–5.5		mV/°C
		GS1 = 0, GS0 = 1			–8.2		mV/°C
		GS1 = 1, GS0 = 0			–10.9		mV/°C
		GS1 = 1, GS0 = 1			–13.6		mV/°C
	Load Regulation(4)	Source ≤ 50 µA, $(V_{DD} - V_{OUT}) \geq 200$ mV			–0.22		mV
			$T_A = T_J = T_{MIN}$ to T_{MAX}			–1	
		Sink ≤ 50 µA, $V_{OUT} \geq 200$ mV			0.26		mV
			$T_A = T_J = T_{MIN}$ to T_{MAX}			1	
	Line Regulation(5)				200		µV/V
I_S	Supply Current	$(V_{DD} - V_{OUT}) \geq 100$ mV			5.4		µA
			$T_A = T_J$ = +30°C to +150°C			8.1	
		$(V_{DD} - V_{OUT}) \geq 100$ mV			5.4		µA
			$T_A = T_J = T_{MIN}$ to T_{MAX}			9	
C_L	Output Load Capacitance				1100		pF
	Power-ON Time(6)	C_L = 0 pF to 1100 pF			0.7		ms
			$T_A = T_J = T_{MIN}$ to T_{MAX}			1.9	
V_{IH}	GS1 and GS0 Input Logic 1 Threshold Voltage	$T_A = T_J = T_{MIN}$ to T_{MAX}		V_{DD} – 0.5			V
V_{IL}	GS1 and GS0 Input Logic 0 Threshold Voltage	$T_A = T_J = T_{MIN}$ to T_{MAX}				0.5	V
I_{IH}	Logic 1 Input Current(7)				0.001		µA
		$T_A = T_J = T_{MIN}$ to T_{MAX}				1	
I_{IL}	Logic 0 Input Current(7)				0.001		µA
		$T_A = T_J = T_{MIN}$ to T_{MAX}				1	

(4) Source currents are flowing out of the LM94022/-Q1. Sink currents are flowing into the LM94022/-Q1.
(5) Line regulation (DC) is calculated by subtracting the output voltage at the highest supply voltage from the output voltage at the lowest supply voltage. The typical DC line regulation specification does not include the output voltage shift discussed in *Output Voltage Shift*.
(6) Warrantied by design and characterization.
(7) The input current is leakage only and is highest at high temperature. It is typically only 0.001 µA. The 1-µA limit is solely based on a testing limitation and does not reflect the actual performance of the part.

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6.6 Typical Characteristics

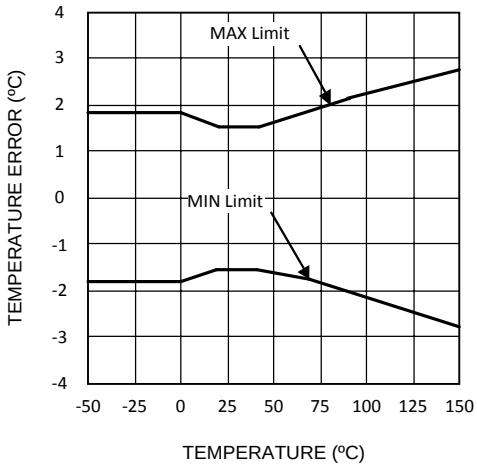

Figure 1. Temperature Error vs. Temperature

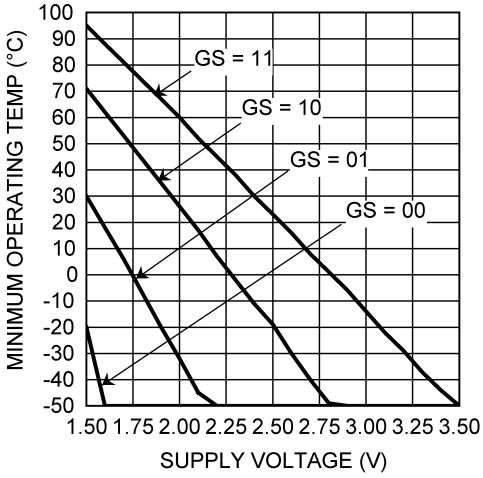

Figure 2. Minimum Operating Temperature vs. Supply Voltage

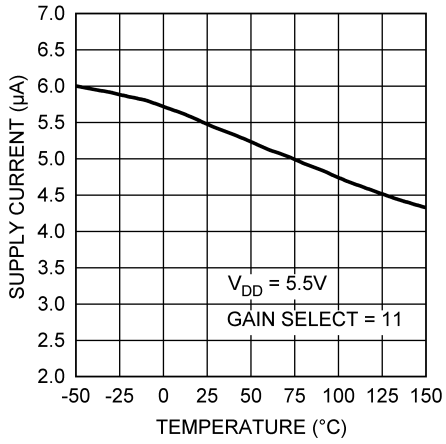

Figure 3. Supply Current vs. Temperature

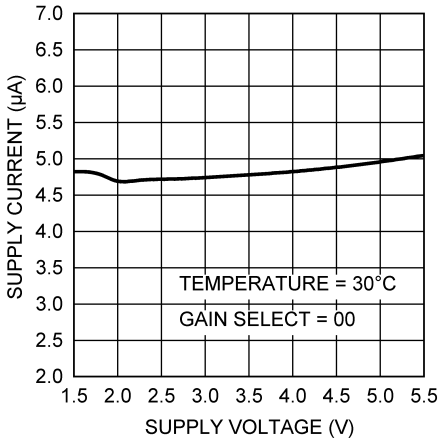

Figure 4. Supply Current vs. Supply Voltage

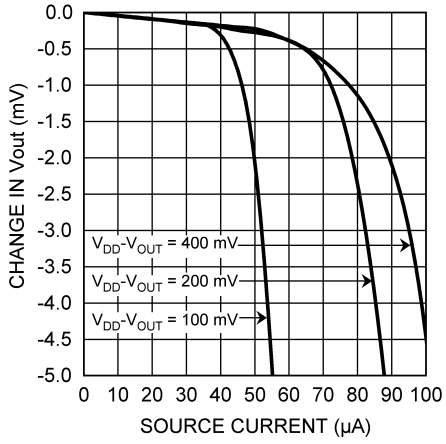

Figure 5. Load Regulation, Sourcing Current

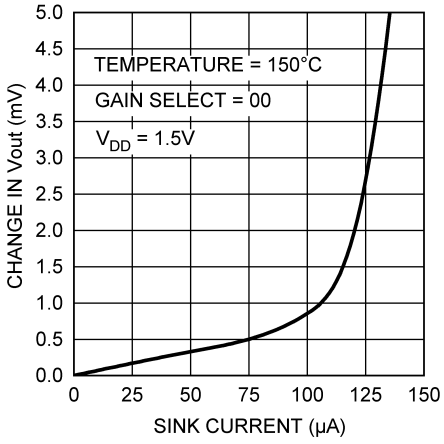

Figure 6. Load Regulation, Sinking Current

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Typical Characteristics (continued)

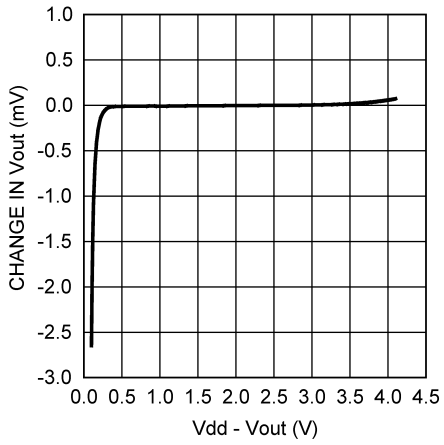

Figure 7. Change in Vout vs. Overhead Voltage

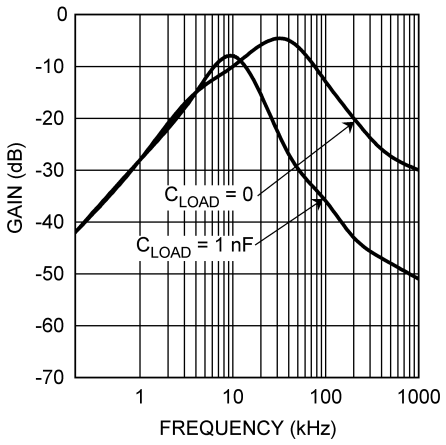

Figure 8. Supply-Noise Gain vs. Frequency

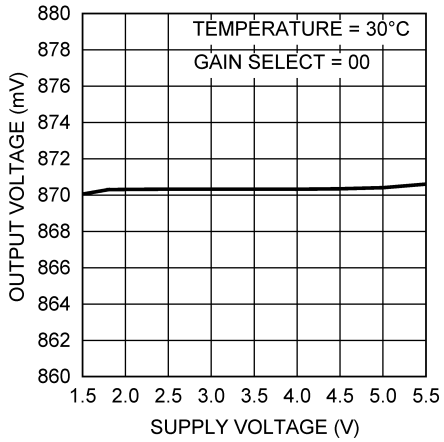

Figure 9. Output Voltage vs. Supply Voltage Gain Select = 00

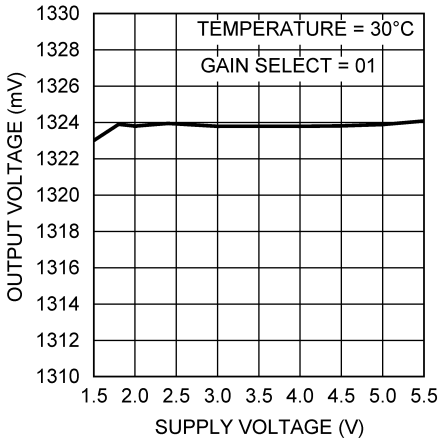

Figure 10. Output Voltage vs. Supply Voltage Gain Select = 01

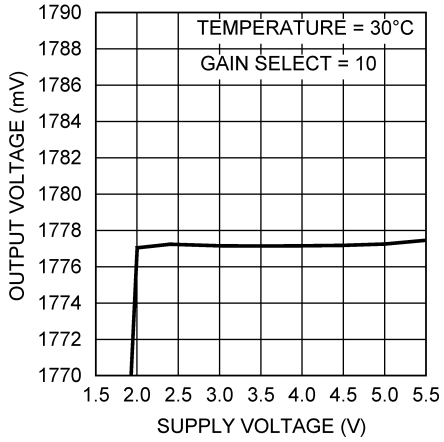

Figure 11. Output Voltage vs. Supply Voltage Gain Select = 10

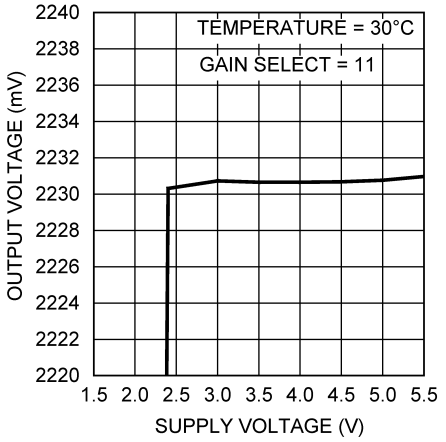

Figure 12. Output Voltage vs. Supply Voltage Gain Select = 11

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7 Detailed Description

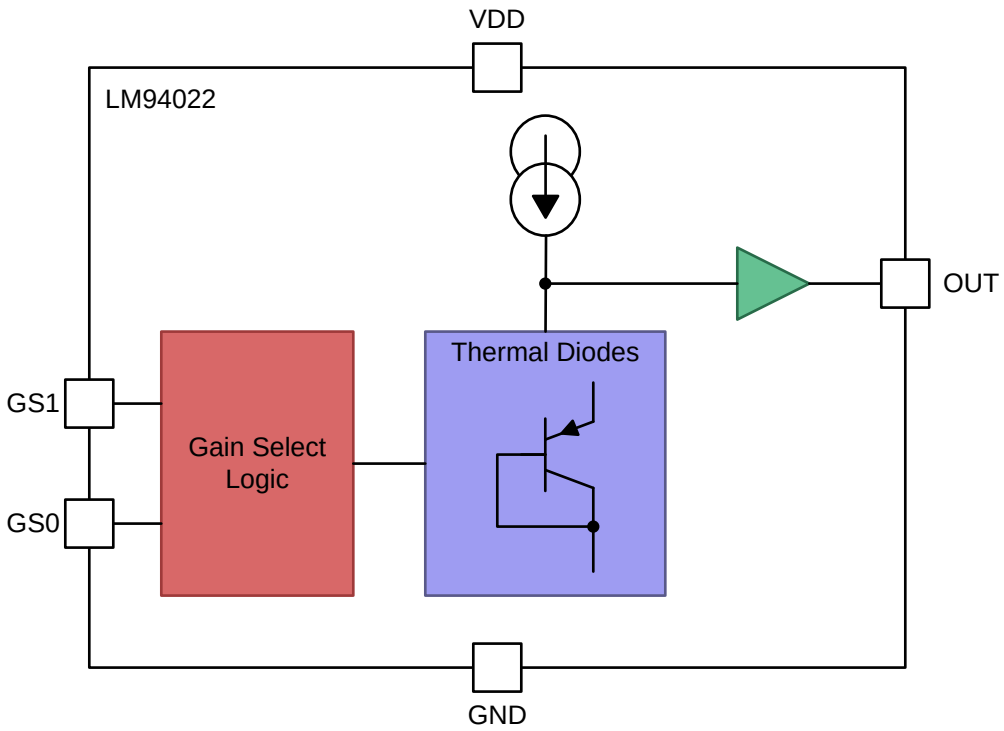
7.1 Overview

The LM94022/-Q1 is an analog output temperature sensor with a selectable negative temperature coefficient output (NTC). The temperature-sensing element is comprised of stacked transistor base emitter junctions (thermal diodes) that are forward biased by a current source. The number of stacked thermal diodes determines the output gain or slope. The gain select pins (GS1 and GS0) are simple logic inputs that control the number of stacked thermal diodes thus selecting the output gain as shown in the Table 1 table. The temperature sensing element is buffered by a simple amplifier that drives the output pin. The simple class AB output stage of the amplifier can source or sink current and provides low-impedance, high-current drive.

Table 1. Gain Select Pin Function

GS1 LOGIC LEVEL	GS0 LOGIC LEVEL	SELECTED AVERAGE GAIN
0	0	–5.5 mV/°C
0	1	–8.2 mV/°C
1	0	–10.9 mV/°C
1	1	–13.6 mV/°C

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 LM94022/-Q1 Transfer Function Gain Selection

The LM94022/-Q1 has four selectable gains, each of which can be selected by the GS1 and GS0 input pins. The output voltage for each gain, across the complete operating temperature range is shown in Table 2. This table is the reference from which the LM94022/-Q1 accuracy specifications (listed in the *Electrical Characteristics* section) are determined. This table can be used, for example, in a host processor look-up table. A file containing this data is available for download at LM94022 product folder under Tools and Software.

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Table 2. LM94022/LM94022-Q1 Transfer Table

TEMPERATURE (°C)	GS = 00 (mV)	GS = 01 (mV)	GS = 10 (mV)	GS = 11 (mV)
–50	1299	1955	2616	3277
–49	1294	1949	2607	3266
–48	1289	1942	2598	3254
–47	1284	1935	2589	3243
–46	1278	1928	2580	3232
–45	1273	1921	2571	3221
–44	1268	1915	2562	3210
–43	1263	1908	2553	3199
–42	1257	1900	2543	3186
–41	1252	1892	2533	3173
–40	1247	1885	2522	3160
–39	1242	1877	2512	3147
–38	1236	1869	2501	3134
–37	1231	1861	2491	3121
–36	1226	1853	2481	3108
–35	1221	1845	2470	3095
–34	1215	1838	2460	3082
–33	1210	1830	2449	3069
–32	1205	1822	2439	3056
–31	1200	1814	2429	3043
–30	1194	1806	2418	3030
–29	1189	1798	2408	3017
–28	1184	1790	2397	3004
–27	1178	1783	2387	2991
–26	1173	1775	2376	2978
–25	1168	1767	2366	2965
–24	1162	1759	2355	2952
–23	1157	1751	2345	2938
–22	1152	1743	2334	2925
–21	1146	1735	2324	2912
–20	1141	1727	2313	2899
–19	1136	1719	2302	2886
–18	1130	1711	2292	2873
–17	1125	1703	2281	2859
–16	1120	1695	2271	2846
–15	1114	1687	2260	2833
–14	1109	1679	2250	2820
–13	1104	1671	2239	2807
–12	1098	1663	2228	2793
–11	1093	1656	2218	2780
–10	1088	1648	2207	2767
–9	1082	1639	2197	2754
–8	1077	1631	2186	2740
–7	1072	1623	2175	2727
–6	1066	1615	2164	2714
–5	1061	1607	2154	2700
–4	1055	1599	2143	2687

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Table 2. LM94022/LM94022-Q1 Transfer Table (continued)

TEMPERATURE (°C)	GS = 00 (mV)	GS = 01 (mV)	GS = 10 (mV)	GS = 11 (mV)
–3	1050	1591	2132	2674
–2	1044	1583	2122	2660
–1	1039	1575	2111	2647
0	1034	1567	2100	2633
1	1028	1559	2089	2620
2	1023	1551	2079	2607
3	1017	1543	2068	2593
4	1012	1535	2057	2580
5	1007	1527	2047	2567
6	1001	1519	2036	2553
7	996	1511	2025	2540
8	990	1502	2014	2527
9	985	1494	2004	2513
10	980	1486	1993	2500
11	974	1478	1982	2486
12	969	1470	1971	2473
13	963	1462	1961	2459
14	958	1454	1950	2446
15	952	1446	1939	2433
16	947	1438	1928	2419
17	941	1430	1918	2406
18	936	1421	1907	2392
19	931	1413	1896	2379
20	925	1405	1885	2365
21	920	1397	1874	2352
22	914	1389	1864	2338
23	909	1381	1853	2325
24	903	1373	1842	2311
25	898	1365	1831	2298
26	892	1356	1820	2285
27	887	1348	1810	2271
28	882	1340	1799	2258
29	876	1332	1788	2244
30	871	1324	1777	2231
31	865	1316	1766	2217
32	860	1308	1756	2204
33	854	1299	1745	2190
34	849	1291	1734	2176
35	843	1283	1723	2163
36	838	1275	1712	2149
37	832	1267	1701	2136
38	827	1258	1690	2122
39	821	1250	1679	2108
40	816	1242	1668	2095
41	810	1234	1657	2081
42	804	1225	1646	2067
43	799	1217	1635	2054

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Table 2. LM94022/LM94022-Q1 Transfer Table (continued)

TEMPERATURE (°C)	GS = 00 (mV)	GS = 01 (mV)	GS = 10 (mV)	GS = 11 (mV)
44	793	1209	1624	2040
45	788	1201	1613	2026
46	782	1192	1602	2012
47	777	1184	1591	1999
48	771	1176	1580	1985
49	766	1167	1569	1971
50	760	1159	1558	1958
51	754	1151	1547	1944
52	749	1143	1536	1930
53	743	1134	1525	1916
54	738	1126	1514	1902
55	732	1118	1503	1888
56	726	1109	1492	1875
57	721	1101	1481	1861
58	715	1093	1470	1847
59	710	1084	1459	1833
60	704	1076	1448	1819
61	698	1067	1436	1805
62	693	1059	1425	1791
63	687	1051	1414	1777
64	681	1042	1403	1763
65	676	1034	1391	1749
66	670	1025	1380	1735
67	664	1017	1369	1721
68	659	1008	1358	1707
69	653	1000	1346	1693
70	647	991	1335	1679
71	642	983	1324	1665
72	636	974	1313	1651
73	630	966	1301	1637
74	625	957	1290	1623
75	619	949	1279	1609
76	613	941	1268	1595
77	608	932	1257	1581
78	602	924	1245	1567
79	596	915	1234	1553
80	591	907	1223	1539
81	585	898	1212	1525
82	579	890	1201	1511
83	574	881	1189	1497
84	568	873	1178	1483
85	562	865	1167	1469
86	557	856	1155	1455
87	551	848	1144	1441
88	545	839	1133	1427
89	539	831	1122	1413
90	534	822	1110	1399

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Table 2. LM94022/LM94022-Q1 Transfer Table (continued)

TEMPERATURE (°C)	GS = 00 (mV)	GS = 01 (mV)	GS = 10 (mV)	GS = 11 (mV)
91	528	814	1099	1385
92	522	805	1088	1371
93	517	797	1076	1356
94	511	788	1065	1342
95	505	779	1054	1328
96	499	771	1042	1314
97	494	762	1031	1300
98	488	754	1020	1286
99	482	745	1008	1272
100	476	737	997	1257
101	471	728	986	1243
102	465	720	974	1229
103	459	711	963	1215
104	453	702	951	1201
105	448	694	940	1186
106	442	685	929	1172
107	436	677	917	1158
108	430	668	906	1144
109	425	660	895	1130
110	419	651	883	1115
111	413	642	872	1101
112	407	634	860	1087
113	401	625	849	1073
114	396	617	837	1058
115	390	608	826	1044
116	384	599	814	1030
117	378	591	803	1015
118	372	582	791	1001
119	367	573	780	987
120	361	565	769	973
121	355	556	757	958
122	349	547	745	944
123	343	539	734	929
124	337	530	722	915
125	332	521	711	901
126	326	513	699	886
127	320	504	688	872
128	314	495	676	858
129	308	487	665	843
130	302	478	653	829
131	296	469	642	814
132	291	460	630	800
133	285	452	618	786
134	279	443	607	771
135	273	434	595	757
136	267	425	584	742
137	261	416	572	728

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Table 2. LM94022/LM94022-Q1 Transfer Table (continued)

TEMPERATURE (°C)	GS = 00 (mV)	GS = 01 (mV)	GS = 10 (mV)	GS = 11 (mV)
138	255	408	560	713
139	249	399	549	699
140	243	390	537	684
141	237	381	525	670
142	231	372	514	655
143	225	363	502	640
144	219	354	490	626
145	213	346	479	611
146	207	337	467	597
147	201	328	455	582
148	195	319	443	568
149	189	310	432	553
150	183	301	420	538

7.4 Device Functional Modes

7.4.1 Capacitive Loads

The LM94022/-Q1 handles capacitive loading well. In an extremely noisy environment, or when driving a switched sampling input on an ADC, it may be necessary to add some filtering to minimize noise coupling. Without any precautions, the LM94022/-Q1 can drive a capacitive load less than or equal to 1100 pF as shown in Figure 13. For capacitive loads greater than 1100 pF, a series resistor may be required on the output, as shown in Figure 14.

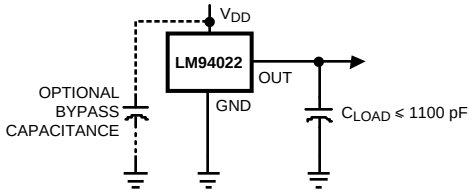

Figure 13. LM94022/-Q1 No Decoupling Required for Capacitive Loads Less than 1100 pF

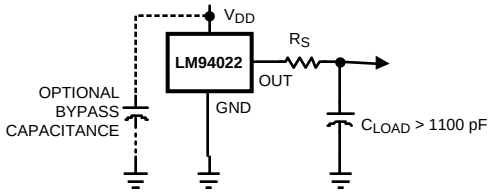

Figure 14. LM94022/-Q1 With Series Resistor for Capacitive Loading Greater than 1100 pF

C_{LOAD}	MINIMUM R_S
1.1 nF to 99 nF	3 kΩ
100 nF to 999 nF	1.5 kΩ
1 µF	800 Ω

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7.4.2 Output Voltage Shift

The LM94022/-Q1 is very linear over temperature and supply voltage range. Due to the intrinsic behavior of an NMOS/PMOS rail-to-rail buffer, a slight shift in the output can occur when the supply voltage is ramped over the operating range of the device. The location of the shift is determined by the relative levels of V_{DD} and V_{OUT}. The shift typically occurs when $V_{DD} – V_{OUT} = 1$ V.

This slight shift (a few mV) takes place over a wide change (approximately 200 mV) in V_{DD} or V_{OUT}. Because the shift takes place over a wide temperature change of 5°C to 20°C, V_{OUT} is always monotonic. The accuracy specifications in the *Electrical Characteristics* table already include this possible shift.

7.4.3 Selectable Gain for Optimization and in Situ Testing

The Gain Select digital inputs can be tied to the rails or can be driven from digital outputs such as microcontroller GPIO pins. In low-supply voltage applications, the ability to reduce the gain to –5.5 mV/°C allows the LM94022/-Q1 to operate over the full –50°C to 150°C range. When a larger supply voltage is present, the gain can be increased as high as –13.6 mV/°C. The larger gain is optimal for reducing the effects of noise (for example, noise coupling on the output line or quantization noise induced by an analog-to-digital converter which may be sampling the LM94022/-Q1 output).

Another application advantage of the digitally selectable gain is the ability to perform dynamic testing of the LM94022/-Q1 while it is running in a system. By toggling the logic levels of the gain select pins and monitoring the resultant change in the output voltage level, the host system can verify the functionality of the LM94022/-Q1.

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8 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

8.1 Application Information

The LM94022/-Q1 features make it suitable for many general temperature sensing applications. It can operate over a supply range of 1.5 V to 5.5 V with programmable output slope and a wide –50°C to +150°C temperature range, thus allowing flexibility for different temperature and supply voltage range combinations.

8.1.1 LM94022 Transfer Function

The LM94022 has four selectable gains, each of which can be selected by the GS1 and GS0 input pins. The output voltage for each gain, across the complete operating temperature range is shown in Table 2. This table is the reference from which the LM94022 accuracy specifications (listed in the *Electrical Characteristics* section) are determined.

Although the LM94022 transfer curves are very linear, they do have a slight umbrella parabolic shape. This shape is very accurately reflected in Table 2. The transfer table was used to calculate the following equations.

$$J2,G00 : V_{TEMP}(mV) = 870.6mV - 5.506\frac{mV}{°C}(T - 30°C) - 0.00176\frac{mV}{°C^2}(T - 30°C)^2$$

$$J3,G01 : V_{TEMP}(mV) = 1324.0mV - 8.194\frac{mV}{°C}(T - 30°C) - 0.00262\frac{mV}{°C^2}(T - 30°C)^2$$

$$J4,G10 : V_{TEMP}(mV) = 1777.3mV - 10.888\frac{mV}{°C}(T - 30°C) - 0.00347\frac{mV}{°C^2}(T - 30°C)^2$$

$$J5,G11 : V_{TEMP}(mV) = 2230.8mV - 13.582\frac{mV}{°C}(T - 30°C) - 0.00433\frac{mV}{°C^2}(T - 30°C)^2 \quad (1)$$

A linear approximation can be useful over a narrow temperature range. A line can easily be calculated over the desired temperature range from the table using the two-point equation:

$$V - V_1 = \left(\frac{V_2 - V_1}{T_2 - T_1}\right) \times (T - T_1)$$

where

- V is in mV,
- T is in °C,
- T_1 and V_1 are the coordinates of the lowest temperature,
- T_2 and V_2 are the coordinates of the highest temperature. (2)

For example, to determine the equation of a line with the Gain Setting at GS1 = 0 and GS0 = 0, over a temperature range of 20°C to 50°C, proceed as follows:

$$V - 925\ mV = \left(\frac{760\ mV - 925\ mV}{50^oC - 20^oC}\right) \times (T - 20^oC) \quad (3)$$

$$V - 925\ mV = (-5.50\ mV / {}^oC) \times (T - 20^oC) \quad (4)$$

$$V = (-5.50\ mV / {}^oC) \times T + 1035\ mV \quad (5)$$

Using this method of linear approximation, the transfer function can be approximated for one or more temperature ranges of interest. The accuracy will suffer slightly in favor of easy conversion of the output voltage to temperature.

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8.2 Typical Application

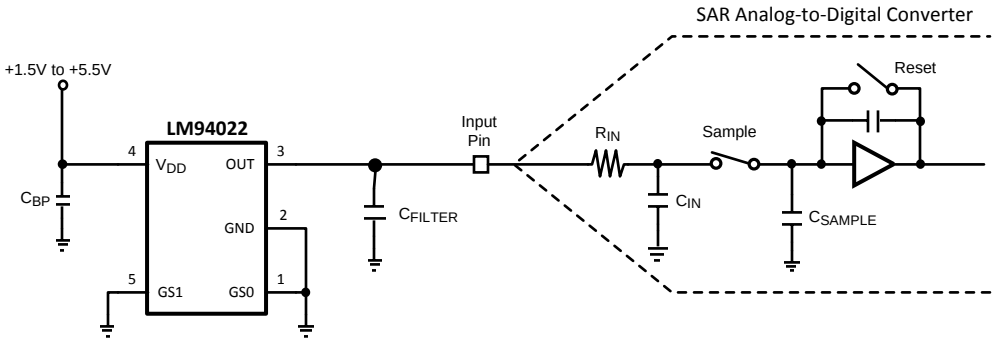

Figure 15. Suggested Connection to a Sampling Analog-to-Digital Converter Input Stage

8.2.1 Design Requirements

Most CMOS ADCs found in microcontrollers and ASICs have a sampled data comparator input structure. When the ADC charges the sampling cap, it requires instantaneous charge from the output of the analog source such as the LM94022/-Q1 temperature sensor and many op amps. This requirement is easily accommodated by the addition of a capacitor (C_{FILTER}).

8.2.2 Detailed Design Procedure

The size of C_{FILTER} depends on the size of the sampling capacitor and the sampling frequency. Since not all ADCs have identical input stages, the charge requirements will vary. This general ADC application is shown as an example only.

8.2.3 Application Curve

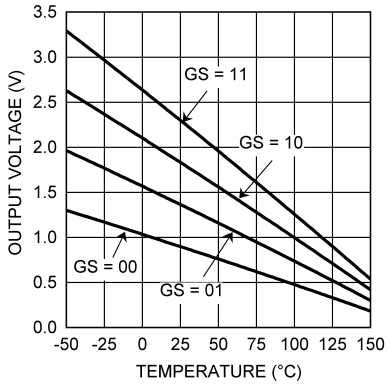

Figure 16. Programmable Analog Output Transfer Function

8.3 System Examples

8.3.1 Application Circuits

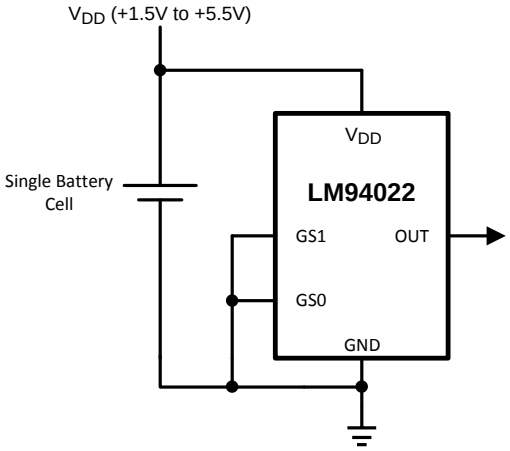

Figure 17. Full-Range Celsius Temperature Sensor (−50°C to +150°C) Operating from a Single Battery Cell

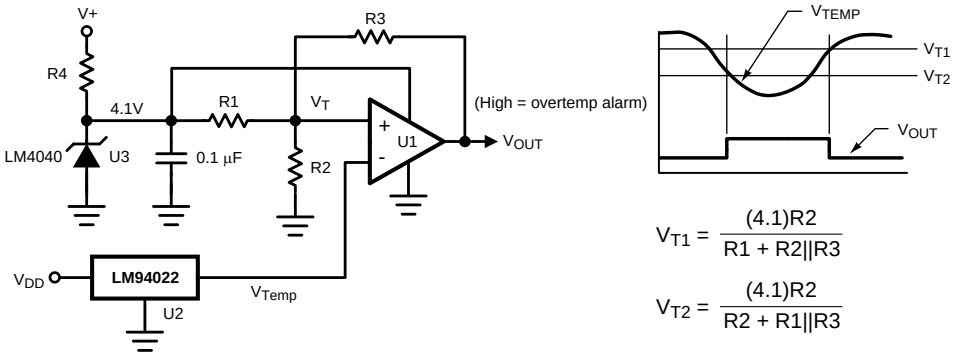

Figure 18. Celsius Thermostat

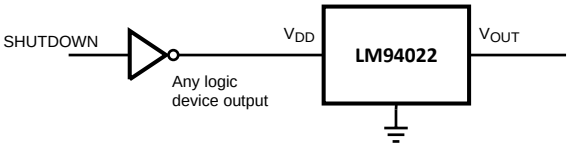

Figure 19. Conserving Power Dissipation With Shutdown

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9 Power Supply Recommendations

The LM94022/-Q1 low supply current and supply range of 1.5 V to 5.5 V allow the device to easily be powered from many sources.

Power supply bypassing is optional and is mainly dependent on the noise on the power supply. In noisy systems it may be necessary to add bypass capacitors to the lower the noise that couples to the output of the LM94022/-Q1.

10 Layout

10.1 Layout Guidelines

10.1.1 Mounting and Thermal Conductivity

The LM94022/-Q1 can be applied easily in the same way as other integrated-circuit temperature sensors. It can be glued or cemented to a surface.

To ensure good thermal conductivity, the backside of the LM94022/-Q1 die is directly attached to the GND pin (Pin 2). The temperatures of the lands and traces to the other leads of the LM94022/-Q1 will also affect the temperature reading.

Alternatively, the LM94022/-Q1 can be mounted inside a sealed-end metal tube, and can then be dipped into a bath or screwed into a threaded hole in a tank. As with any IC, the LM94022/-Q1 and accompanying wiring and circuits must be kept insulated and dry, to avoid leakage and corrosion. This is especially true if the circuit may operate at cold temperatures where condensation can occur. If moisture creates a short circuit from the output to ground or V_{DD}, the output from the LM94022/-Q1 will not be correct. Printed-circuit coatings are often used to ensure that moisture cannot corrode the leads or circuit traces.

The thermal resistance junction to ambient (θ_{JA}) is the parameter used to calculate the rise of a device junction temperature due to its power dissipation. The equation used to calculate the rise in the die temperature of the LM94022/-Q1 is:

$$T_J = T_A + \theta_{JA}\left[(V_{DD}I_Q) + (V_{DD} - V_O)\ I_L \right] \quad (6)$$

where

- T_A is the ambient temperature,
- I_Q is the quiescent current,
- $I_L$is the load current on the output,
- and V_O is the output voltage.

For example, in an application where T_A = 30 °C, V_{DD} = 5 V, I_{DD} = 9 µA, Gain Select = 11, V_{OUT} = 2.231 mV, and I_L = 2 µA, the junction temperature would be 30.021 °C, showing a self-heating error of only 0.021°C. Because the junction temperature of the LM94022 is the actual temperature being measured, take care to minimize the load current that the LM94022/-Q1 is required to drive. Table 3 shows the thermal resistance of the LM94022/-Q1.

Table 3. LM94022/LM94022-Q1 Thermal Resistance

DEVICE NUMBER	NS PACKAGE NUMBER	THERMAL RESISTANCE (θ_{JA})
LM94022BIMG	DCK0005A	415°C/W

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10.2 Layout Example

The LM94022/-Q1 is extremely simple to layout electrically. If a power supply bypass capacitor is used it should be connected as shown in Figure 20. The device pins and layout greatly influence the temperature that the LM94022/-Q1 die is measuring thus thermal modeling is recommended to ensure that the device is sensing the proper temperature.

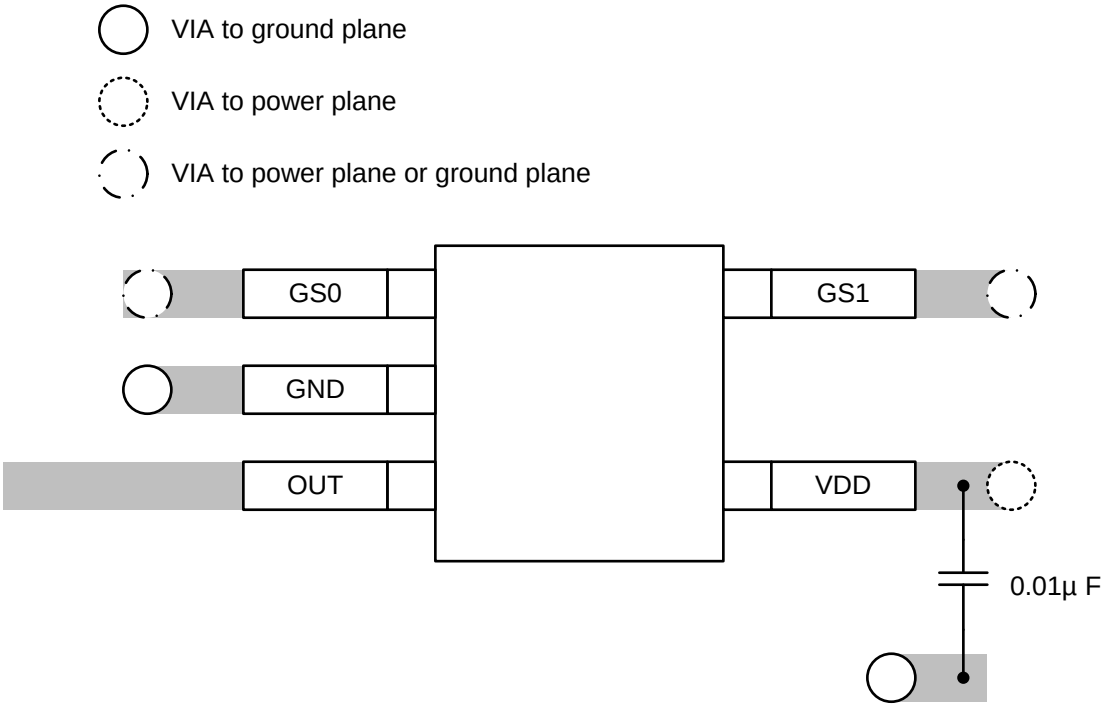

Figure 20. Recommended Layout

10.3 Output and Noise Considerations

A push-pull output gives the LM94022/-Q1 the ability to sink and source significant current. This is beneficial when, for example, driving dynamic loads like an input stage on an analog-to-digital converter (ADC). In these applications the source current is required to quickly charge the input capacitor of the ADC. See the *Application Circuits* section for more discussion of this topic. The LM94022/-Q1 is ideal for this and other applications which require strong source or sink current.

The supply-noise gain of the LM94022 (the ratio of the AC signal on V_{OUT} to the AC signal on V_{DD}) was measured during bench tests. It is typical attenuation is shown in the *Typical Characteristics* section. A load capacitor on the output can help to filter noise.

For operation in very noisy environments, some bypass capacitance should be present on the supply within approximately 2 inches of the LM94022/-Q1.

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11 Device and Documentation Support

11.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

Table 4. Related Links

PARTS	PRODUCT FOLDER	SAMPLE & BUY	TECHNICAL DOCUMENTS	TOOLS & SOFTWARE	SUPPORT & COMMUNITY
LM94022	Click here	Click here	Click here	Click here	Click here
LM94022-Q1	Click here	Click here	Click here	Click here	Click here

11.2 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community ***TI's Engineer-to-Engineer (E2E) Community.*** Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

Design Support ***TI's Design Support*** Quickly find helpful E2E forums along with design support tools and contact information for technical support.

11.3 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

11.4 Electrostatic Discharge Caution

These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

11.5 Glossary

SLYZ022 — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package | Pins	Package qty | Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
LM94022BIMG	NRND	Production	SC70 (DCK) | 5	1000 | LARGE T&R	No	Call TI	Call TI	-50 to 150	22B
LM94022BIMG.A	NRND	Production	SC70 (DCK) | 5	1000 | LARGE T&R	No	Call TI	Call TI	-50 to 150	22B
LM94022BIMG.B	NRND	Production	SC70 (DCK) | 5	1000 | LARGE T&R	No	Call TI	Call TI	-50 to 150	22B
LM94022BIMGX/NOPB	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-50 to 150	22B
LM94022BIMGX/NOPB.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-50 to 150	22B
LM94022BIMGX/NOPB.B	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-50 to 150	22B
LM94022QBIMGX/NOPB	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-50 to 150	22Q
LM94022QBIMGX/NOPB.A	Active	Production	SC70 (DCK) | 5	3000 | LARGE T&R	Yes	SN	Level-1-260C-UNLIM	-50 to 150	22Q

(1) **Status:** For more details on status, see our product life cycle.

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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OTHER QUALIFIED VERSIONS OF LM94022, LM94022-Q1 :

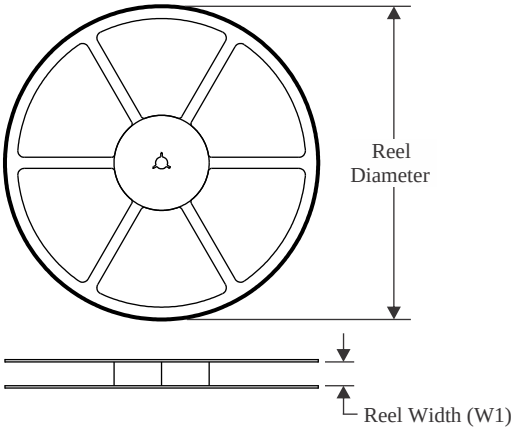
- Catalog : LM94022
- Automotive : LM94022-Q1

NOTE: Qualified Version Definitions:

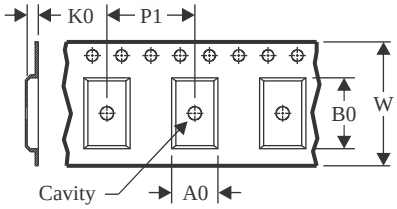
- Catalog - TI's standard catalog product
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

TAPE AND REEL INFORMATION

REEL DIMENSIONS

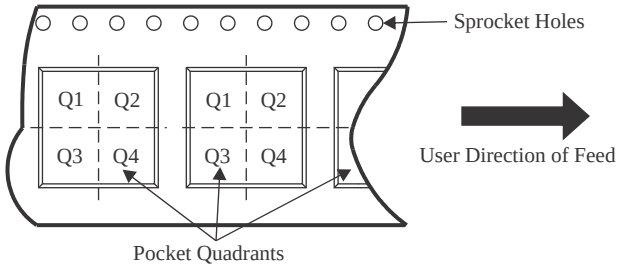


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

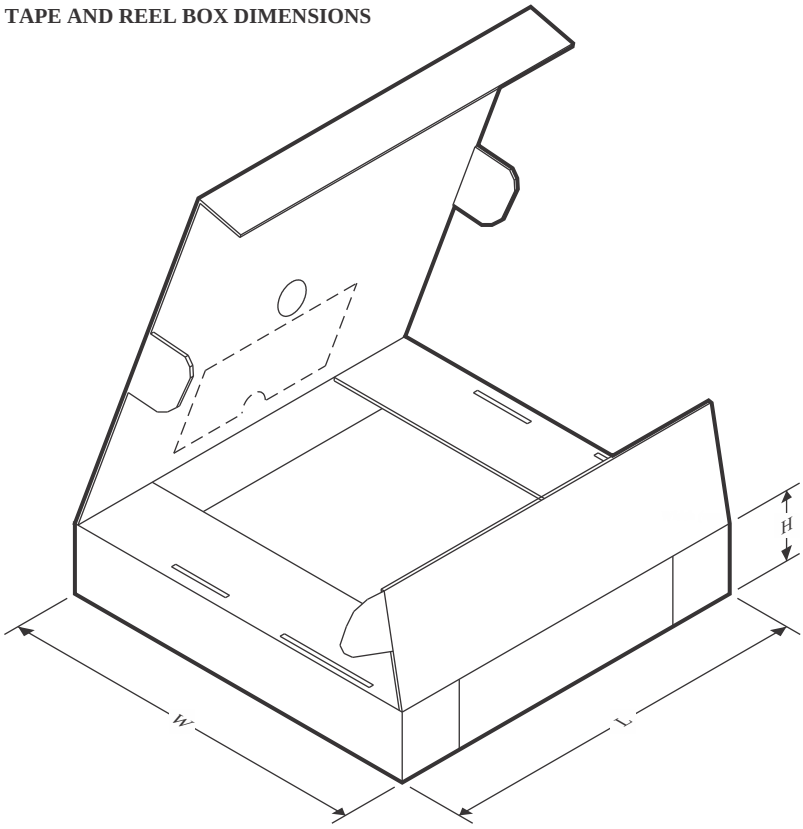
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM94022BIMGX/NOPB	SC70	DCK	5	3000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3
LM94022QBIMGX/NOPB	SC70	DCK	5	3000	178.0	8.4	2.25	2.45	1.2	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

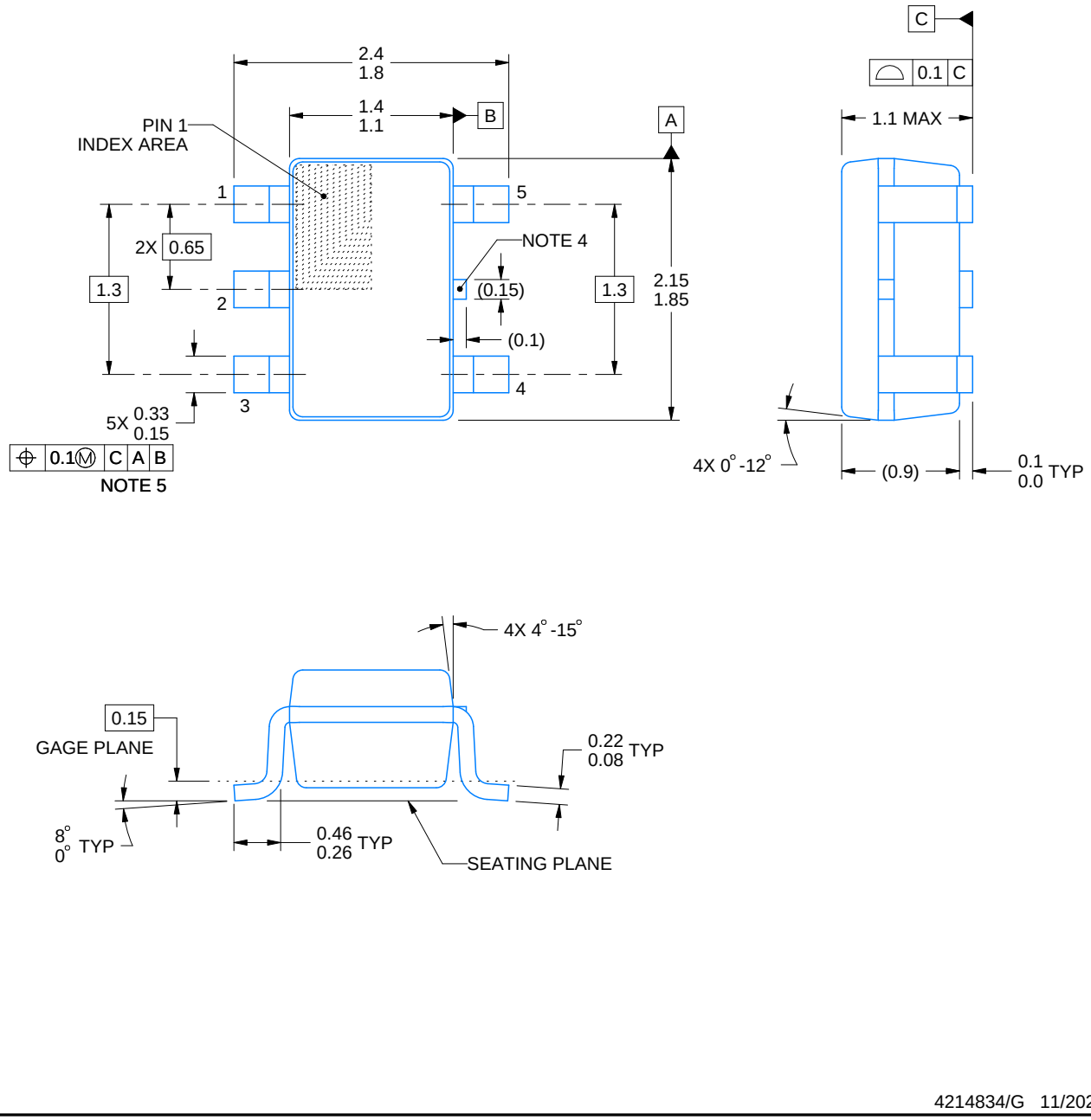
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM94022BIMGX/NOPB	SC70	DCK	5	3000	208.0	191.0	35.0
LM94022QBIMGX/NOPB	SC70	DCK	5	3000	208.0	191.0	35.0

PACKAGE OUTLINE

DCK0005A

SOT - 1.1 max height

SMALL OUTLINE TRANSISTOR



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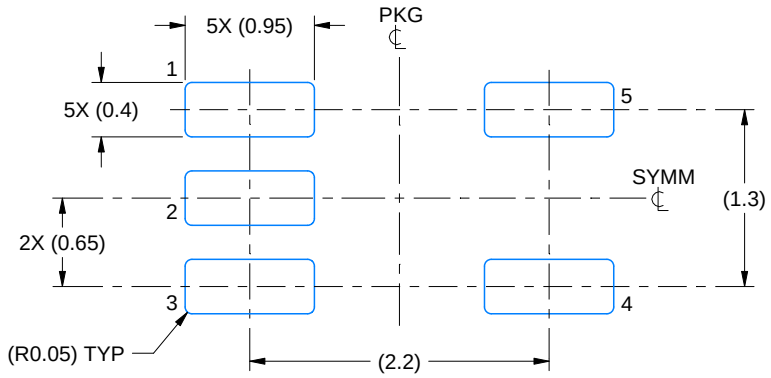
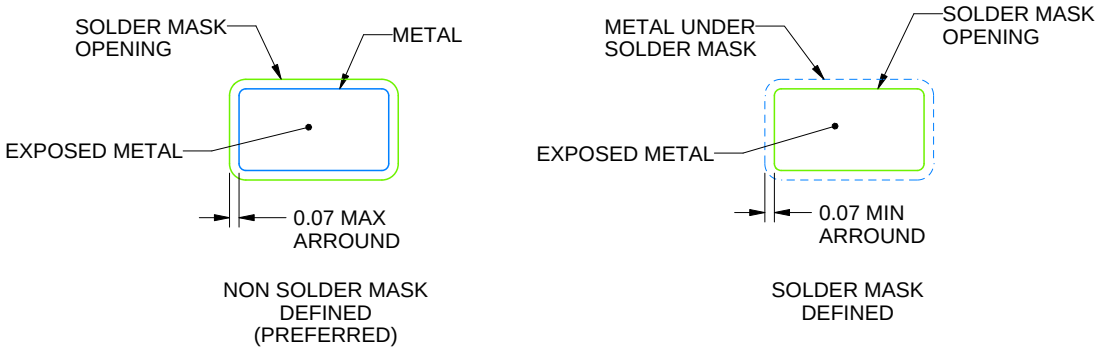
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Refernce JEDEC MO-203.
4. Support pin may differ or may not be present.
5. Lead width does not comply with JEDEC.
6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X



SOLDER MASK DETAILS

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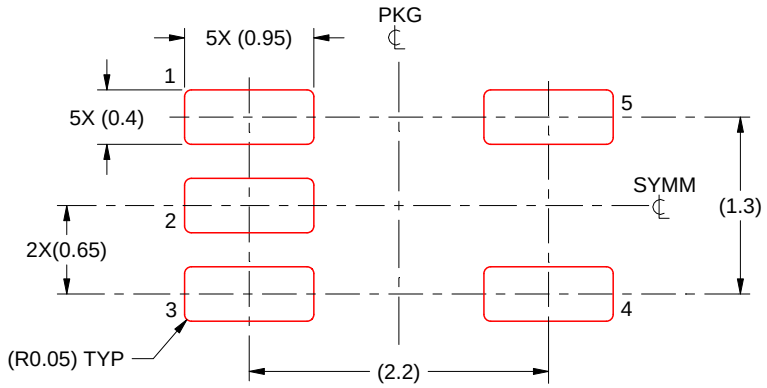
NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:18X

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NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

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